



課 綱 Course Outline
電機工程學系學士班半導體工程組

中文課程名稱 Course Name in Chinese	積體電路佈局設計實驗				
英文課程名稱 Course Name in English	IC Layout Design Laboratory				
科目代碼 Course Code	EE__33730	班 別 Degree	學士班 Bachelor' s		
修別 Type	學程 Program	學分數 Credit(s)	1.0	時 數 Hour(s)	1.0
先修課程 Prerequisite	電子學(一)/電子學(二)				
課程目標 Course Objectives					
1. 具備使用晶片設計模擬軟體之能力。 2. 具備類比電路佈局設計與模擬之能力。 3. 了解類比晶片下線實作之流程。					
系教育目標 Dept.'s Education Objectives					
1	專業人才培育—奠立學生專業知能，培育產業技術人才。 To cultivate talents with basic professional knowledge				
2	團隊合作訓練—落實分工合作觀念，具備溝通服從能力。 To train students with teamwork ability				
3	創新思維啟發—具備自我學習能力，啟發創新思維模式。 To inspire students with creative thinking				
4	多元學習規劃—訓練觸類旁通思維，培養基本科技英文閱讀溝通能力。 To plan courses with multi-learning modes				
系專業能力 Basic Learning Outcomes				課程目標與系專業能力相關性 Correlation between Course Objectives and Dept.'s Education Objectives	
A	培育具備工程、應用數學與物理科學等數理知識之基本能力。 To cultivate the basic knowledge of engineering, applied mathematics and physics.			●	
B	培育系統分析、模擬驗證、實作實現之能力。 To cultivate the basic ability of analysis, verification and implementation of systems.			●	

C	訓練軟體工具使用與硬體實務驗證相互輔助之能力。 To train the auxiliary ability between the utilization of software tool and the verification of the hardware practice.	●
D	訓練電機本知學能技術與工程實務相互結合運用之能力。 To train the integrate ability between professional instinct in learning technique and engineering practice.	●
E	落實專題製作之群體合作與團隊競爭之能力。 To fulfill the ability of group cooperation and teamwork competition.	●
F	落實發掘問題、邏輯分析、克服瓶頸與持續學習之能力 To fulfill the ability of question finding, logical analyzing, bottleneck overcoming and continuous learning.	●
G	了解學術倫理與智慧財產觀念，掌握產業更迭需求與具備多元專長之能力。 To obtain the ability of multi-specialization and to meet the industry demand as well as to have the ability of academic ethics and concept of intellectual property	○
H	了解國內外市場變化，具備基本科技英文閱讀溝通之能力。 To understand the change of global market and the have the basic ability of reading and conversation in English.	○

圖示說明Illustration：● 高度相關 Highly correlated ○ 中度相關 Moderately correlated

課程大綱 Course Outline

1. 晶片設計流程與軟體介紹
2. 工作站使用與基本操作教學
3. Schematic Technique --- H-Spice Practice
4. Layout Technique --- Cadence Practice
5. Calibre --- DRC & LVS
6. Chip Implementation --- I/O Pad
7. Project
8. Final Presentation

資源需求評估（師資專長之聘任、儀器設備的配合．．．等）
Resources Required (e.g. qualifications and expertise, instrument and equipment, etc.)

1. 具積體電路設計專長之專任教師。
2. 配合VLSI實驗室工作站進行授課

課程要求和教學方式之建議 Course Requirements and Suggested Teaching Methods

1. 理論分析與設計模擬驗證並重。
2. 配合期末專題完成實務晶片下線製作流程。

其他 Miscellaneous